

## **Power line chokes**

Current-compensated ring core double chokes 250 V AC, 0.3 ... 2 A, 1.1 ... 22 mH

Series/Type: B82720S

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#### **Current-compensated ring core double chokes**

**SMD** 

Rated voltage 250 V AC
Rated current 0.3 A to 2 A
Rated inductance 1.1 mH to 22 mH



#### Construction

- Current-compensated ring core double choke
- Ferrite core
- LCP case (UL 94 V-0)
- Silicone potting
- Sector winding

#### **Features**

- Approx. 0.8% stray inductance for differential-mode interference suppression
- Suitable for reflow soldering
- Design complies with EN 60938-2 (VDE 0565-2)
- RoHS-compatible

#### **Applications**

- Suppression of common-mode interferences
- Compact electronic ballasts in lamps
- Compact switch-mode power supplies

#### **Terminals**

- Base material CuSn6
- Layer composition Ni, Sn
- Hot-dipped

#### Marking

- Marking on component: Manufacturer, ordering code, rated inductance, rated current, graphic symbol, rated voltage, date of manufacture (YYWWD)
- Minimum data on reel:
   Manufacturer, ordering code, rated inductance, rated current, quantity, date of packing

#### Delivery mode and packing unit

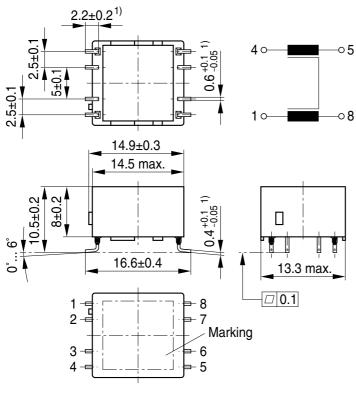
- 24-mm blister tape, wound on 330-mm Ø reel
- Packing unit: 350 pcs./reel



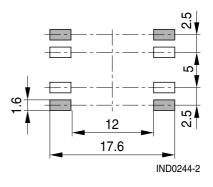
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#### Dimensional drawing and pin configuration



Layout recommendation



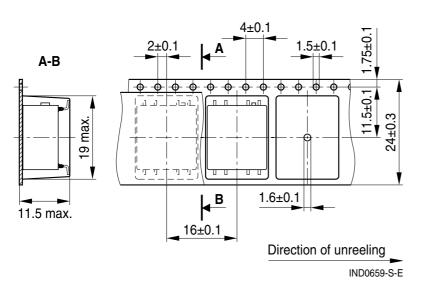
1) Soldering area

IND0243-T-E

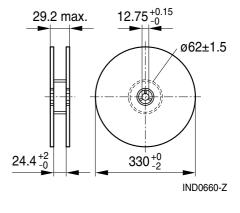
Dimensions in mm

### **Taping and packing**

Blister tape



Reel



Dimensions in mm



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## Technical data and measuring conditions

Rated voltage V <sub>R</sub>	250 V AC (50/60 Hz)			
Test voltage V <sub>test</sub>	1500 V AC, 2 s (line/line)			
Rated temperature T <sub>R</sub>	40 °C			
Rated current I <sub>R</sub>	Referred to 50 Hz and rated temperature			
Rated inductance L <sub>R</sub>	Measured with Agilent 4284A at 10 kHz, 0.1 mA, 20 °C Inductance is specified per winding.			
Inductance tolerance	−30/+50% at 20 °C			
Inductance decrease ΔL/L <sub>0</sub>	< 10% at DC magnetic bias with I <sub>R</sub> , 20 °C			
Stray inductance L <sub>stray,typ</sub>	Measured with Agilent 4284A at 10 kHz, 5 mA, 20 °C, typical values			
DC resistance R <sub>typ</sub>	Measured at 20 °C, typical values, specified per winding			
Solderability (lead free)	Sn96.5Ag3.0Cu0.5: (245 $\pm$ 5) °C, (3 $\pm$ 0.3) s Wetting of soldering area $\geq$ 95% (to IEC 60068-2-58, test Td)			
Resistance to soldering heat	(260 ±5) °C, (10 ±1) s (to IEC 60068-2-58, test Td)			
Climatic category	40/125/56 (to IEC 60068-1)			
Storage conditions (packaged)	–25 °C +40 °C, ≤ 75% RH			
Weight	Approx. 2.5 g			

## **Characteristics and ordering codes**

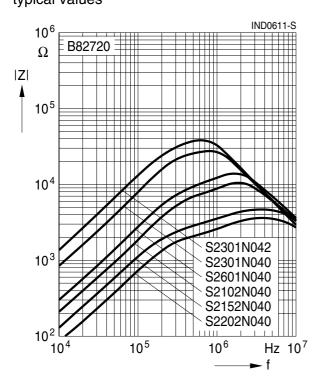
$\overline{I_R}$	L <sub>R</sub>	L <sub>stray,typ</sub>	R <sub>typ</sub>	Ordering code
Α	mH	μН	m $Ω$	
0.3	22	130	1500	B82720S2301N042
0.3	12	80	1100	B82720S2301N040
0.6	4.4	30	400	B82720S2601N040
1.0	3.0	20	220	B82720S2102N040
1.5	1.6	10	110	B82720S2152N040
2.0	1.1	6	65	B82720S2202N040



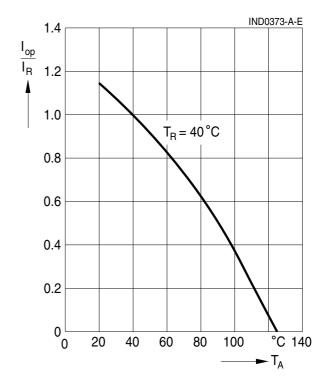
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## Impedance IZI versus frequency f measured with windings in parallel at 20 °C, typical values



# Current derating $I_{op}/I_R$ versus temperature $T_A$



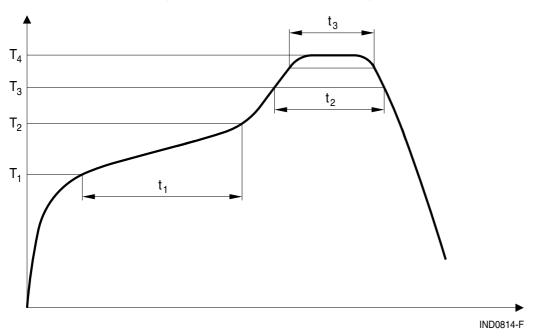


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## Recommended reflow soldering profile

Pb-free solder material (based on JEDEC J-STD 020C)



T <sub>1</sub>	T <sub>2</sub>	T <sub>3</sub>	T <sub>4</sub>	t <sub>1</sub>	t <sub>2</sub>	t <sub>3</sub>
°C	°C	°C	°C	S	S	S
150	200	217	245	< 110	< 90	< 30 @ T <sub>4</sub> –5 °C

Time from 25  $^{\circ}$ C to T<sub>4</sub>: max 300 s Max. numbers of reflow cycles: 3



#### **Cautions and warnings**

- Please note the recommendations in our Inductors data book (latest edition) and in the data sheets.
  - Particular attention should be paid to the derating curves given there.
  - The soldering conditions should also be observed. Temperatures quoted in relation to wave soldering refer to the pin, not the housing.
- If the components are to be washed varnished it is necessary to check whether the washing varnish agent that is used has a negative effect on the wire insulation, any plastics that are used, or on glued joints. In particular, it is possible for washing varnish agent residues to have a negative effect in the long-term on wire insulation.
- The following points must be observed if the components are potted in customer applications:
  - Many potting materials shrink as they harden. They therefore exert a pressure on the plastic housing or core. This pressure can have a deleterious effect on electrical properties, and in extreme cases can damage the core or plastic housing mechanically.
  - It is necessary to check whether the potting material used attacks or destroys the wire insulation, plastics or glue.
  - The effect of the potting material can change the high-frequency behaviour of the components.
- Ferrites are sensitive to direct impact. This can cause the core material to flake, or lead to breakage of the core.
- Even for customer-specific products, conclusive validation of the component in the circuit can only be carried out by the customer.



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